

# MEMS & IMAGING SENSORS SUMMIT

## POST SHOW REPORT

MEMS & Imaging Sensors Summit | 19 - 21 Sep 2018 | Grenoble, France

### Event Highlights

- **404** international registered attendees in total
- From **25** countries
- **6** keynotes and more than **50** invited speakers
- **57** exhibitors
- **10** demos at MEMS & Imaging Technology Showcase
- **16** sponsors
- More than **30** association and media partners
- **Networking** opportunities and **B2B Matchmaking** onsite

### Executive Keynote Speeches

- **Opening**  
Jean-Marc Chery, President and CEO, STMicroelectronics
- **Sensors, Cars and the Road Ahead**  
Lars Reger, Senior VP and Automotive Chief Technology Officer, NXP Semiconductors
- **Sensors: Key Enabler of Autonomous Driving**  
Luc Bourgeois, Expert Leader ADAS and AD systems, Renault
- **Sensors Technologies: From Data Acquisition to Embedded Information**  
Emmanuel Sabonnadiere, CEO, CEA-Leti
- **Introduction of Sensor Ecosystem in China**  
Teng Gao, President, FIOT-LAB
- **From Cloud to Edge: the Smart City and Personal Data**  
Claus Habfast, Vice-Chair, Grenoble Metropolitan Council

### 2018 MEMS & Sensors Technology Showcase

The Technology Showcase highlights some of the newest and most unique MEMS/imaging/sensors-enabled applications in the industry. Each winner of MEMS/SENSORS Technology and IMAGING/SENSORS Technology gets to have a free booth the following year. The winners for the year 2018 were:

- MEMS/SENSORS Technology - Mirsense
- IMAGING/SENSORS Technology - XenomatiX

Congratulations to Mirsense & XenomatiX and enjoy your free booth at MEMS & Imaging Sensors Summit 2019!

## Key Attending Companies

- Accurion
- ActLight SA
- AMEC
- Amkor Technology
- ams
- Applied Materials
- ASE Group
- Bosch Sensortec
- Cadence Design Systems
- Caeleste
- Carl Zeiss SMT
- CEA-Leti
- DELO Industrial Adhesives
- Dotphoton
- EV Group (EVG)
- First Sensor Microelectronic Packaging
- Fraunhofer IPMS
- FotoNation
- Fujifilm Electronic Materials
- Gpixel
- Grenoble-Alpes Métropole
- Huawei
- IHS Markit
- Infineon Technologies
- Invest in Grenoble-Alps
- IRLYNX
- JSR Micro
- KAIAM
- Kokusai Semiconductor Europe
- KST World
- Lam Research
- LFoundry
- Lucendi, Inc.
- MASER Engineering BV
- Materion
- Micalyne Inc.
- MirSense
- National Nanofab Center
- Nikon Precision Europe
- NXP Semiconductors
- Okmetic Oy
- OnScale
- Presto Engineering
- Qualcomm
- Renault
- Robert Bosch
- Safran Colibrys
- SICK AG
- Siconnex customized solutions
- SILIOS Technologies
- Soitec
- SPEKTRA GmbH Dresden
- SPTS Technologies
- STMicroelectronics
- SUSS MicroTec
- TDK TRONICS
- Teledyne DALSA Semiconductor
- Teledyne e2v
- Toppan Printing
- Trymax Semiconductor
- TSMC Europe
- TUSK IC
- USound
- VON ARDENNE
- VTT
- Xenomatix
- XIMEA
- XPERI | Invensas
- Yole Développement

## 2018 Sponsors

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